

## Optocoupler, Phototransistor Output (Dual, Quad Channel)

### Features

- Alternate Source to TLP621-2/-4 and TLP621GB-2/-4
- High Collector-Emitter Voltage,  $BV_{CEO}=70\text{ V}$
- Dual and Quad Packages Feature:
  - Lower Pin and Parts Count
  - Better Channel to Channel CTR Match
  - Improved Common Mode Rejection
- Isolation Test Voltage  $5300\text{ V}_{RMS}$

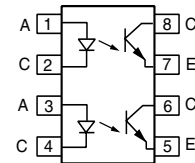
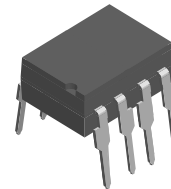
### Agency Approvals

- UL File # E52744 System Code H or J
- DIN EN 60747-5-2(VDE0884)  
DIN EN 60747-5-5 pending  
Available with Option 1
- BSI IEC60950 IEC60965
- FIMKO

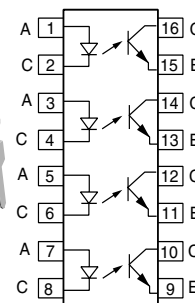
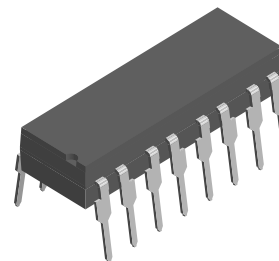
### Description

The ILD621/ ILQ621 and ILD621GB/ ILQ621GB are multi-channel phototransistor optocouplers that use GaAs IRLED emitters and high gain NPN silicon phototransistors. These devices are constructed using double molded insulation technology. This assembly process offers a withstand test voltage of 7500 VDC. The ILD621/ ILQ621GB is well suited for CMOS interfacing given the  $CTR_{CE\text{ sat}}$  of 30 % minimum at  $I_F$  of 1.0 mA. High gain linear operation is guaranteed by a minimum  $CTR_{CE}$  of 100 % at 5.0 mA. The ILD/Q621 has a guaranteed  $CTR_{CE}$  50 % minimum at 5.0 mA. The TRansparent IOn Shield insures stable DC gain in applications such as power supply feedback circuits, where constant DC  $V_{IO}$  voltages are present.

Dual Channel



Quad Channel



### Order Information

| Part          | Remarks                                |
|---------------|----------------------------------------|
| ILD621        | CTR > 50 %, DIP-8                      |
| ILD621GB      | CTR > 100 %, DIP-8                     |
| ILQ621        | CTR > 50 %, DIP-16                     |
| ILQ621GB      | CTR > 100 %, DIP-16                    |
| ILD621-X006   | CTR > 50 %, DIP-8 400 mil (option 6)   |
| ILD621-X007   | CTR > 50 %, SMD-8 (option 7)           |
| ILD621-X009   | CTR > 50 %, SMD-8 (option 9)           |
| ILD621GB-X007 | CTR > 100 %, SMD-8 (option 7)          |
| ILQ621-X006   | CTR > 50 %, DIP-8 400 mil (option 6)   |
| ILQ621-X007   | CTR > 50 %, SMD-16 (option 7)          |
| ILQ621-X009   | CTR > 50 %, SMD-16 (option 9)          |
| ILQ621GB-X006 | CTR > 100 %, DIP-16 400 mil (option 6) |
| ILQ621GB-X007 | CTR > 100 %, SMD-16 (option 7)         |
| ILQ621GB-X009 | CTR > 100 %, SMD-16 (option 9)         |

For additional information on the available options refer to Option Information.

### Absolute Maximum Ratings

$T_{amb} = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified

Stresses in excess of the absolute Maximum Ratings can cause permanent damage to the device. Functional operation of the device is not implied at these or any other conditions in excess of those given in the operational sections of this document. Exposure to absolute Maximum Rating for extended periods of the time can adversely affect reliability.

### Input

| Parameter         | Test condition | Symbol     | Value | Unit  |
|-------------------|----------------|------------|-------|-------|
| Reverse voltage   |                | $V_R$      | 6.0   | V     |
| Forward current   |                | $I_F$      | 60 mA | mA    |
| Surge current     |                | $I_{FSM}$  | 1.5   | A     |
| Power dissipation |                | $P_{diss}$ | 100   | mW    |
| Derate from 25 °C |                |            | 1.33  | mW/°C |

### Output

| Parameter                          | Test condition      | Symbol     | Value | Unit  |
|------------------------------------|---------------------|------------|-------|-------|
| Collector -emitter reverse voltage |                     | $V_{ECO}$  | 70    | V     |
| Collector current                  |                     | $I_C$      | 50    | mA    |
|                                    | $t < 1.0\text{ ms}$ | $I_C$      | 100   | mA    |
| Power dissipation                  |                     | $P_{diss}$ | 150   | mW    |
| Derate from 25 °C                  |                     |            | - 2.0 | mW/°C |

### Coupler

| Parameter              | Test condition                                                 | Part     | Symbol    | Value          | Unit      |
|------------------------|----------------------------------------------------------------|----------|-----------|----------------|-----------|
| Isolation test voltage | $t = 1.0\text{ sec.}$                                          |          | $V_{ISO}$ | 5300           | $V_{RMS}$ |
| Package dissipation    |                                                                | ILD621   |           | 400            | mW        |
|                        |                                                                | ILD621GB |           | 400            | mW        |
| Derate from 25 °C      |                                                                |          |           | 5.33           | mW/°C     |
| Package dissipation    |                                                                | ILQ621   |           | 500            | mW        |
|                        |                                                                | ILQ621GB |           | 500            | mW        |
| Derate from 25 °C      |                                                                |          |           | 6.67           | mW/°C     |
| Creepage               |                                                                |          |           | $\geq 7.0$     | mm        |
| Clearance              |                                                                |          |           | $\geq 7.0$     | mm        |
| Isolation resistance   | $V_{IO} = 500\text{ V}, T_{amb} = 25\text{ }^{\circ}\text{C}$  |          | $R_{IO}$  | $\geq 10^{12}$ | $\Omega$  |
|                        | $V_{IO} = 500\text{ V}, T_{amb} = 100\text{ }^{\circ}\text{C}$ |          | $R_{IO}$  | $\geq 10^{11}$ | $\Omega$  |
| Storage temperature    |                                                                |          | $T_{stg}$ | - 55 to +150   | °C        |
| Operating temperature  |                                                                |          | $T_{amb}$ | - 55 to +100   | °C        |
| Junction temperature   |                                                                |          | $T_j$     | 100            | °C        |
| Soldering temperature  | 2.0 mm from case bottom                                        |          | $T_{sld}$ | 260            | °C        |



## Electrical Characteristics

$T_{amb} = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified

Minimum and maximum values are testing requirements. Typical values are characteristics of the device and are the result of engineering evaluation. Typical values are for information only and are not part of the testing requirements.

## Input

| Parameter                            | Test condition                   | Symbol     | Min | Typ. | Max | Unit          |
|--------------------------------------|----------------------------------|------------|-----|------|-----|---------------|
| Forward voltage                      | $I_F = 10\text{ mA}$             | $V_F$      | 1.0 | 1.15 | 1.3 | V             |
| Reverse current                      | $V_R = 6.0\text{ V}$             | $I_R$      |     | 0.01 | 10  | $\mu\text{A}$ |
| Capacitance                          | $V_F = 0$ , $f = 1.0\text{ MHz}$ | $C_O$      |     | 40   |     | pF            |
| Thermal resistance, Junction to lead |                                  | $R_{THJL}$ |     | 750  |     | K/W           |

## Output

| Parameter                            | Test condition                                 | Symbol     | Min | Typ. | Max | Unit          |
|--------------------------------------|------------------------------------------------|------------|-----|------|-----|---------------|
| Collector-emitter capacitance        | $V_{CE} = 5.0\text{ V}$ , $f = 1.0\text{ MHz}$ | $C_{CE}$   |     | 6.8  |     | pF            |
| Collector-emitter leakage current    | $V_{CE} = 24\text{ V}$                         | $I_{CEO}$  |     | 10   | 100 | nA            |
|                                      |                                                | $I_{CEO}$  |     | 20   | 50  | $\mu\text{A}$ |
| Thermal resistance, Junction to lead |                                                | $R_{THJL}$ |     | 500  |     | K/W           |

## Coupler

| Parameter                            | Test condition                                   | Part                 | Symbol      | Min       | Typ. | Max | Unit     |
|--------------------------------------|--------------------------------------------------|----------------------|-------------|-----------|------|-----|----------|
| Capacitance (input-output)           | $V_{IO} = 0\text{ V}$ , $f = 1.0\text{ MHz}$     |                      | $C_{IO}$    | 0.8       |      |     | pF       |
| Insulation resistance                | $V_{IO} = 500\text{ V}$                          |                      |             | $10^{12}$ |      |     | $\Omega$ |
| Channel to channel insulation        |                                                  |                      |             | 500       |      |     | VAC      |
| Collector-emitter saturation voltage | $I_F = 8.0\text{ mA}$ , $I_{CE} = 2.4\text{ mA}$ | ILD621<br>ILQ621     | $V_{CEsat}$ |           |      | 0.4 | V        |
|                                      | $I_F = 1.0\text{ mA}$ , $I_{CE} = 0.2\text{ mA}$ | ILD621GB<br>ILQ621GB | $V_{CEsat}$ |           |      | 0.4 | V        |

## Current Transfer Ratio

| Parameter                                               | Test condition                                  | Part                 | Symbol        | Min    | Typ. | Max    | Unit |
|---------------------------------------------------------|-------------------------------------------------|----------------------|---------------|--------|------|--------|------|
| Channel/Channel CTR match                               | $I_F = 5.0\text{ mA}$ , $V_{CE} = 5.0\text{ V}$ |                      | CTRX/<br>CTRY | 1 to 1 |      | 3 to 1 |      |
| Current Transfer Ratio<br>(collector-emitter saturated) | $I_F = 1.0\text{ mA}$ , $V_{CE} = 0.4\text{ V}$ | ILD621<br>ILQ621     | $CTR_{CEsat}$ |        | 60   |        | %    |
|                                                         |                                                 | ILD621GB<br>ILQ621GB | $CTR_{CEsat}$ | 30     |      |        | %    |
| Current Transfer Ratio<br>(collector-emitter)           | $I_F = 5.0\text{ mA}$ , $V_{CE} = 5.0\text{ V}$ | ILD621<br>ILQ621     | $CTR_{CE}$    | 50     | 80   | 600    | %    |
|                                                         |                                                 | ILD621GB<br>ILQ621GB | $CTR_{CE}$    | 100    | 200  | 600    | %    |

### Switching Characteristics

Non-saturated switching timing

| Parameter       | Test condition                                                                                 | Symbol    | Min | Typ. | Max | Unit          |
|-----------------|------------------------------------------------------------------------------------------------|-----------|-----|------|-----|---------------|
| On Time         | $I_F = \pm 10 \text{ mA}$ , $V_{CC} = 5.0 \text{ V}$ ,<br>$R_L = 75 \Omega$ , 50 % of $V_{PP}$ | $t_{on}$  |     | 3.0  |     | $\mu\text{s}$ |
| Rise time       | $I_F = \pm 10 \text{ mA}$ , $V_{CC} = 5.0 \text{ V}$ ,<br>$R_L = 75 \Omega$ , 50 % of $V_{PP}$ | $t_r$     |     | 2.0  |     | $\mu\text{s}$ |
| Off time        | $I_F = \pm 10 \text{ mA}$ , $V_{CC} = 5.0 \text{ V}$ ,<br>$R_L = 75 \Omega$ , 50 % of $V_{PP}$ | $t_{off}$ |     | 2.3  |     | $\mu\text{s}$ |
| Fall time       | $I_F = \pm 10 \text{ mA}$ , $V_{CC} = 5.0 \text{ V}$ ,<br>$R_L = 75 \Omega$ , 50 % of $V_{PP}$ | $t_f$     |     | 2.0  |     | $\mu\text{s}$ |
| Propagation H-L | $I_F = \pm 10 \text{ mA}$ , $V_{CC} = 5.0 \text{ V}$ ,<br>$R_L = 75 \Omega$ , 50 % of $V_{PP}$ | $t_{PHL}$ |     | 1.1  |     | $\mu\text{s}$ |
| Propagation L-H | $I_F = \pm 10 \text{ mA}$ , $V_{CC} = 5.0 \text{ V}$ ,<br>$R_L = 75 \Omega$ , 50 % of $V_{PP}$ | $t_{PLH}$ |     | 2.5  |     | $\mu\text{s}$ |

Saturated switching timing

| Parameter       | Test condition                                                                                                   | Symbol    | Min | Typ. | Max | Unit          |
|-----------------|------------------------------------------------------------------------------------------------------------------|-----------|-----|------|-----|---------------|
| On time         | $I_F = \pm 10 \text{ mA}$ , $V_{CC} = 5.0 \text{ V}$ ,<br>$R_L = 1.0 \text{ K}\Omega$ , $V_{TH} = 1.5 \text{ V}$ | $t_{on}$  |     | 4.3  |     | $\mu\text{s}$ |
| Rise time       | $I_F = \pm 10 \text{ mA}$ , $V_{CC} = 5.0 \text{ V}$ ,<br>$R_L = 1.0 \text{ K}\Omega$ , $V_{TH} = 1.5 \text{ V}$ | $t_r$     |     | 2.8  |     | $\mu\text{s}$ |
| Off time        | $I_F = \pm 10 \text{ mA}$ , $V_{CC} = 5.0 \text{ V}$ ,<br>$R_L = 1.0 \text{ K}\Omega$ , $V_{TH} = 1.5 \text{ V}$ | $t_{off}$ |     | 2.5  |     | $\mu\text{s}$ |
| Fall time       | $I_F = \pm 10 \text{ mA}$ , $V_{CC} = 5.0 \text{ V}$ ,<br>$R_L = 1.0 \text{ K}\Omega$ , $V_{TH} = 1.5 \text{ V}$ | $t_f$     |     | 11   |     | $\mu\text{s}$ |
| Propagation H-L | $I_F = \pm 10 \text{ mA}$ , $V_{CC} = 5.0 \text{ V}$ ,<br>$R_L = 1.0 \text{ K}\Omega$ , $V_{TH} = 1.5 \text{ V}$ | $t_{PHL}$ |     | 2.6  |     | $\mu\text{s}$ |
| Propagation L-H | $I_F = \pm 10 \text{ mA}$ , $V_{CC} = 5.0 \text{ V}$ ,<br>$R_L = 1.0 \text{ K}\Omega$ , $V_{TH} = 1.5 \text{ V}$ | $t_{PLH}$ |     | 7.2  |     | $\mu\text{s}$ |

### Common Mode Transient Immunity

| Parameter                         | Test condition                                                                         | Symbol | Min | Typ. | Max | Unit                   |
|-----------------------------------|----------------------------------------------------------------------------------------|--------|-----|------|-----|------------------------|
| Common mode rejection output high | $V_{CM} = 50 \text{ V}_{P-P}$ , $R_L = 1.0 \text{ K}\Omega$ ,<br>$I_F = 0 \text{ mA}$  | $CM_H$ |     | 5000 |     | $\text{V}/\mu\text{s}$ |
| Common mode rejection output low  | $V_{CM} = 50 \text{ V}_{P-P}$ , $R_L = 1.0 \text{ K}\Omega$ ,<br>$I_F = 10 \text{ mA}$ | $CM_L$ |     | 5000 |     | $\text{V}/\mu\text{s}$ |

## Typical Characteristics ( $T_{amb} = 25\text{ }^{\circ}\text{C}$ unless otherwise specified)

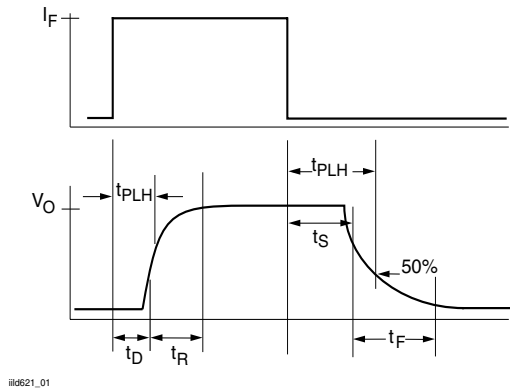


Fig. 1 Non-saturated Switching Timing

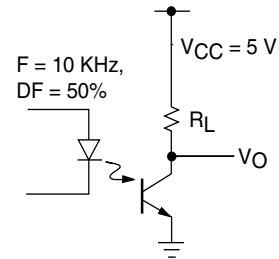


Fig. 4 Saturated Switching Timing

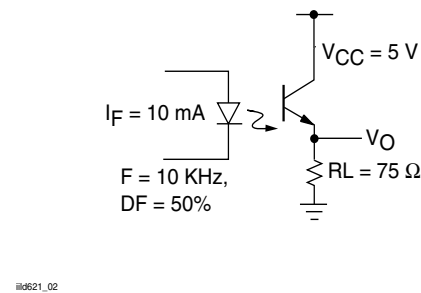


Fig. 2 Non-saturated Switching Timing

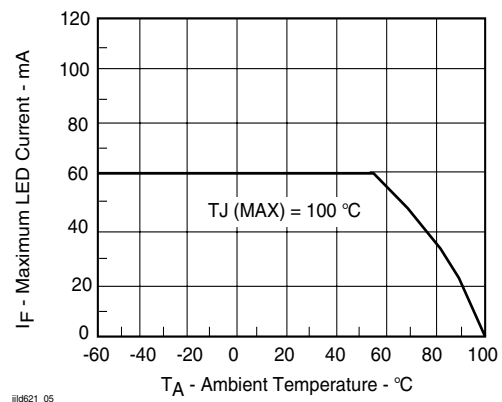


Fig. 5 Maximum LED Current vs. Ambient Temperature

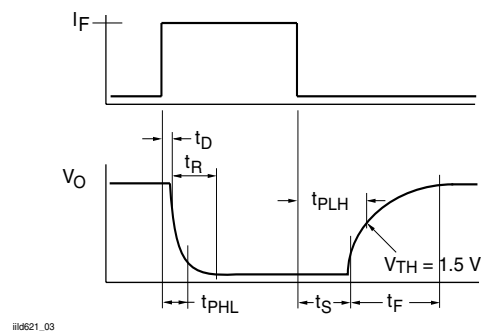


Fig. 3 Saturated Switching Timing

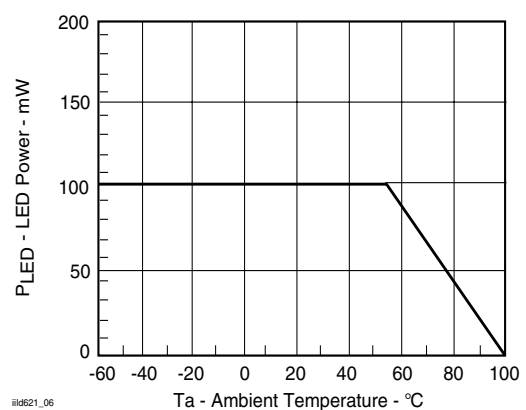
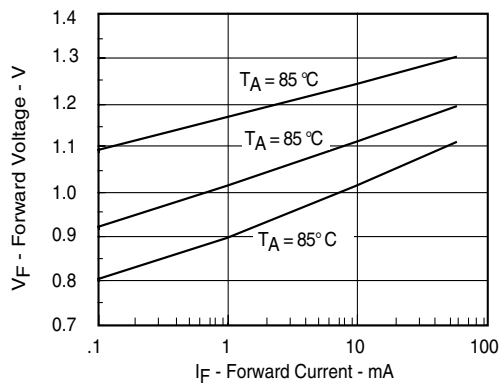
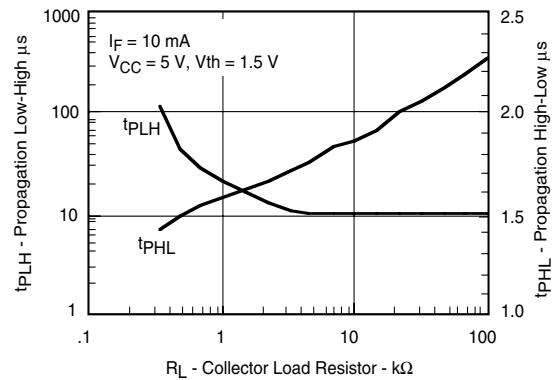


Fig. 6 Maximum LED Power Dissipation



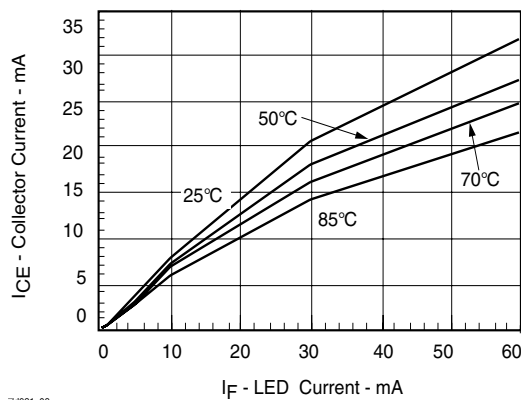
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Fig. 7 Forward Voltage vs. Forward Current



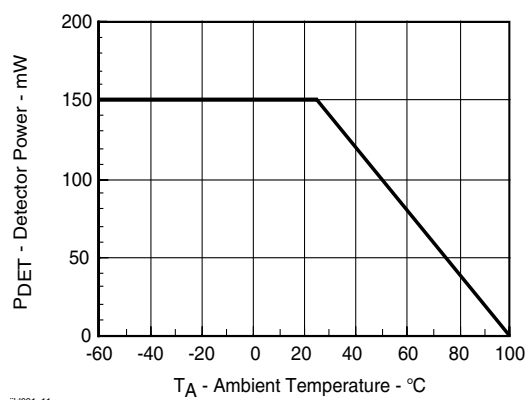
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Fig. 10 Propagation Delay vs. Collector Load Resistor



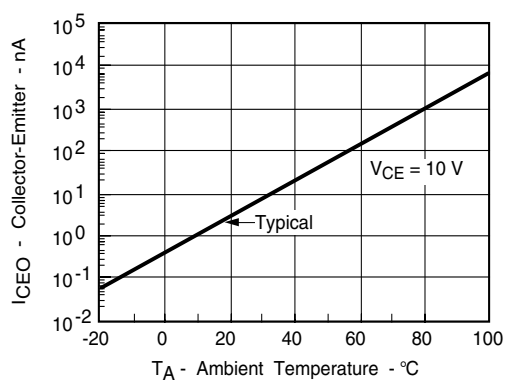
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Fig. 8 Collector-Emitter Current vs. Temperature and LED Current



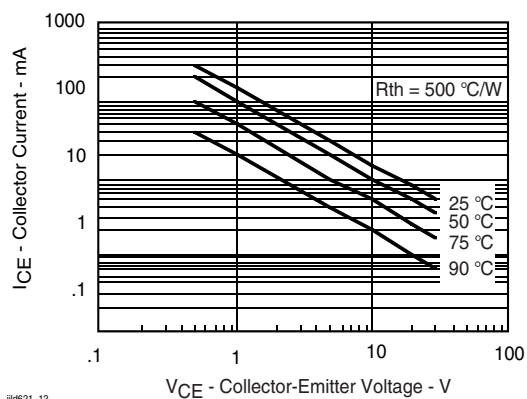
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Fig. 11 Maximum Detector Power Dissipation



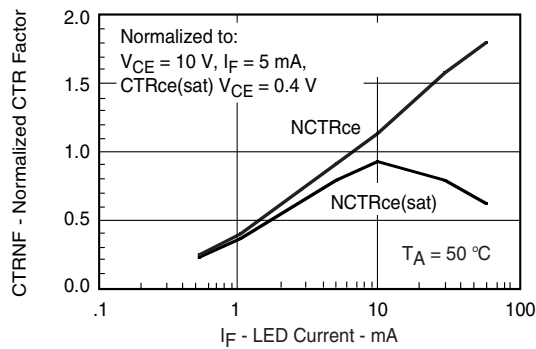
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Fig. 9 Collector-Emitter Leakage vs. Temperature



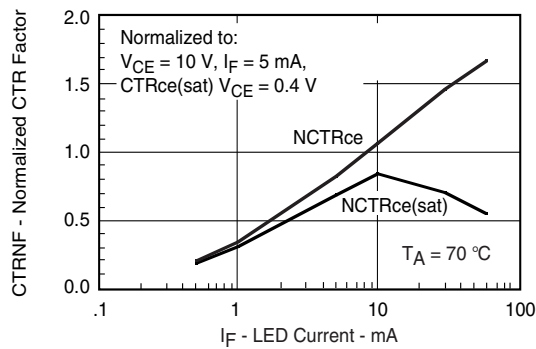
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Fig. 12 Maximum Collector Current vs. Collector Voltage



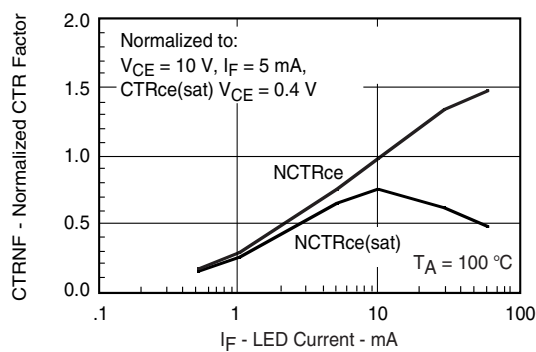
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Fig. 13 Normalization Factor for Non-saturated and Saturated CTR vs.  $I_F$



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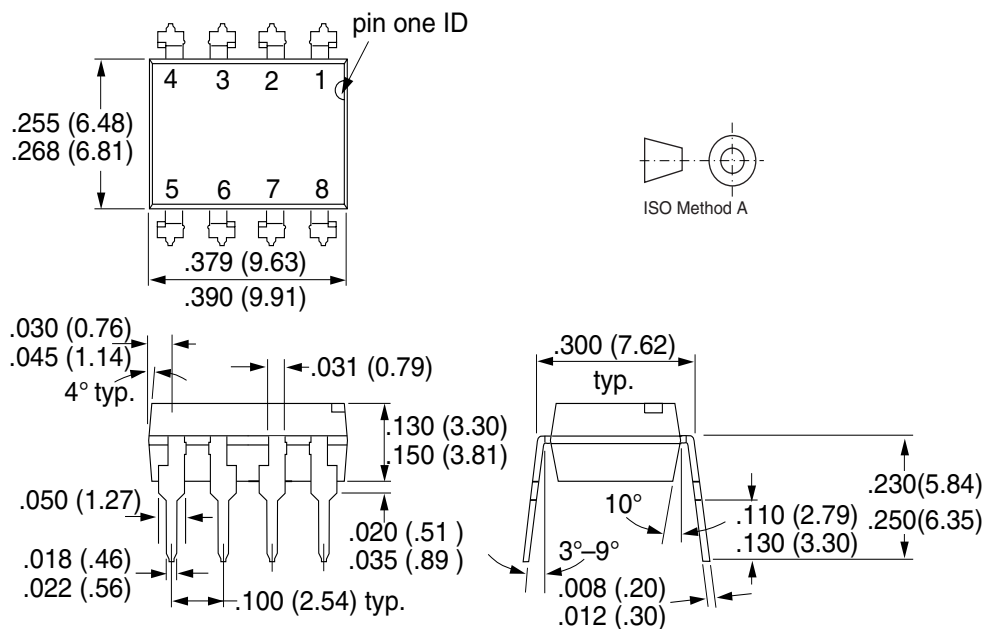
Fig. 14 Normalization Factor for Non-saturated and Saturated CTR vs.  $I_F$



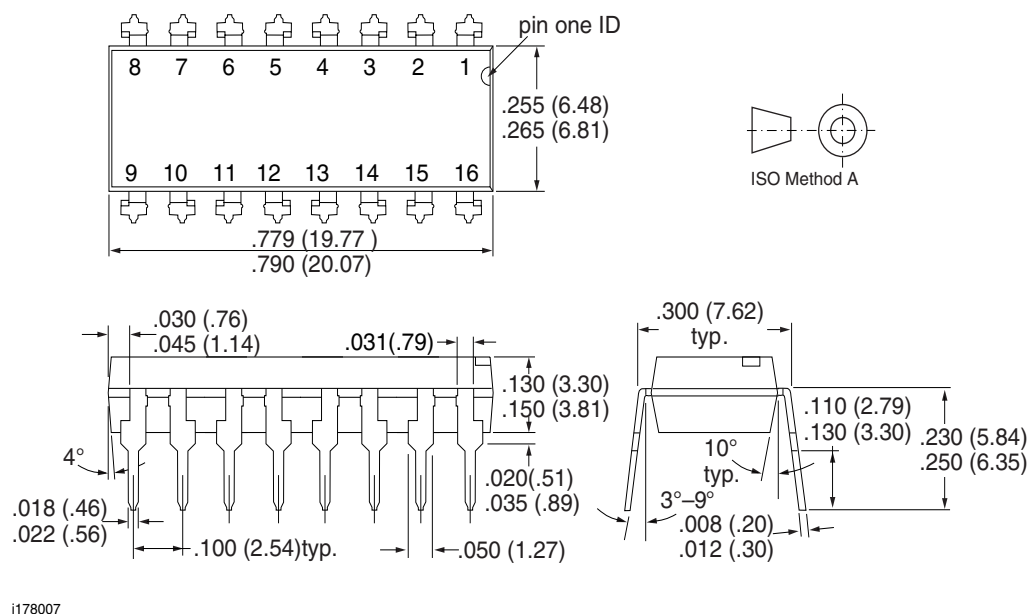
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Fig. 15 Normalization Factor for Non-saturated and Saturated CTR vs.  $I_F$

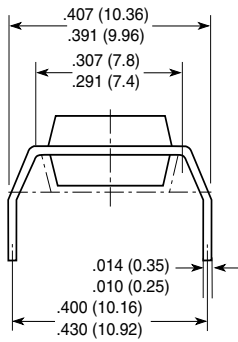
## Package Dimensions in Inches (mm)



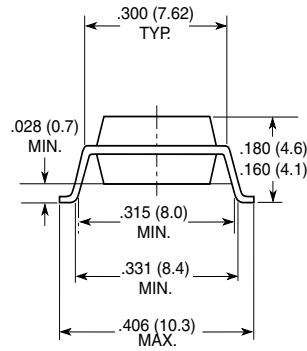
## Package Dimensions in Inches (mm)



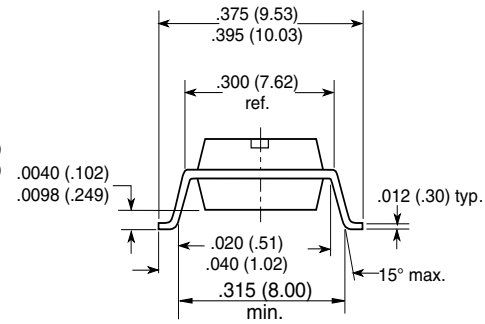
**Option 6**



**Option 7**



**Option 9**



18450

### Ozone Depleting Substances Policy Statement

It is the policy of **Vishay Semiconductor GmbH** to

1. Meet all present and future national and international statutory requirements.
2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

**Vishay Semiconductor GmbH** has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively
2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA
3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

**Vishay Semiconductor GmbH** can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

**We reserve the right to make changes to improve technical design  
and may do so without further notice.**

Parameters can vary in different applications. All operating parameters must be validated for each customer application by the customer. Should the buyer use Vishay Semiconductors products for any unintended or unauthorized application, the buyer shall indemnify Vishay Semiconductors against all claims, costs, damages, and expenses, arising out of, directly or indirectly, any claim of personal damage, injury or death associated with such unintended or unauthorized use.

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